

30A SCHOTTKY BARRIER RECTIFIER

Features

- Low Forward Voltage Drop
- · Soft, Fast Switching Capability
- Schottky Barrier Chip
- ITO-220S Heat Sink Tab Electrically Isolated from Cathode
- UL Approval in Accordance with UL 1557, Reference No. E94661

Mechanical Data

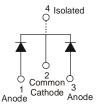
- Case: ITO-220S
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin Finish annealed over Copper leadframe.
 Solderable per MIL-STD-202, Method 208 63
- Weight: 1.335 grams (approximate)







Bottom View



Package Pin Out Configuration

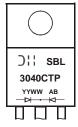
Ordering Information (Notes 1 & 2)

Part Number	Case	Packaging
SBL3040CTP	ITO-220S	50 pieces/tube
SBL3040CTP-G	ITO-220S	50 pieces/tube

Notes:

- 1. For packaging details, go to our website at http://www.diodes.com.
- 2. For Green Molding compound version part number, add "-G" suffix to part number. Example: SBL3040CTP-G.

Marking Information



SBL3040CTP = Product Type Marking Code AB = Foundry and Assembly Code YYWW = Date Code Marking YY = Last two digits of year (ex: 08 = 2008) WW = Week (01 - 53)



Maximum Ratings (Per Leg) @TA = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic		Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _{RM}	40	٧	
Average Rectified Output Current	(Per Leg) (Total)	lo	15 30	A	
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load		I _{FSM}	230	А	
Isolation Voltage From Terminal Heatsink t = 1 min.		V_{AC}	2000	V	

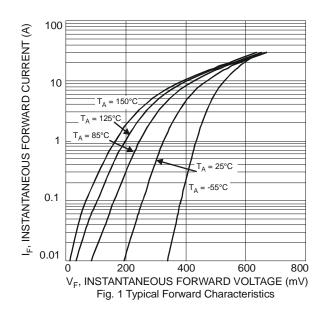
Thermal Characteristics (Per Leg)

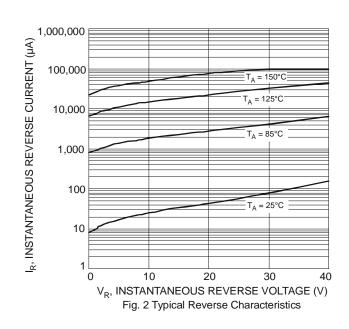
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Case	$R_{ heta}$ JC	3	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (Per Leg) @T_A = 25°C unless otherwise specified

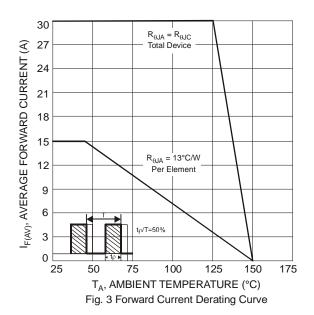
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	V_{F}	-	-	0.60	V	$I_F = 15A, T_J = 25^{\circ}C$
Leakage Current (Note 3)	1-	-	0.15	1	i ma i	$V_R = 40V, T_J = 25^{\circ}C$
Leakage Current (Note 3)	IR	-	-	75		$V_R = 40V, T_J = 100^{\circ}C$

Notes: 3. Short duration pulse test used to minimize self-heating effect.

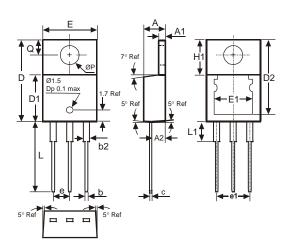








Package Outline Dimensions



	ITO-220S					
DIM.	MIN.	MAX.	TYP.			
Α	4.52	4.62	4.57			
A 1	0.51	1.39	_			
A2	2.57	2.77	2.67			
b	0.72	0.95	0.84			
b2	1.15	1.54	1.26			
С	0.356	0.61	-			
D	14.22	16.51	15.00			
D1	8.60	8.80	8.70			
D2	13.68	14.08	_			
е	2.49	2.59	2.54			
e1	4.98	5.18	5.08			
Е	10.01	10.21	10.11			
E1	6.86	8.89	_			
H1	5.85	6.85	_			
L	13.30	13.90	13.60			
L1	_	4.00	_			
Р	3.54	4.08	_			
Q	2.54	3.42	_			
All	All Dimensions in mm					



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